

WHAT IS CLAIMED IS:

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1. A connection inspecting apparatus for inspecting
connection of a connected part, which comprises:

an irradiation part (111) for applying a
5 radiation to the connected part of members with an
application condition kept invariant;

a scintillator (115) for converting a radiation
passed through the connected part to a visible light;

an imaging device (120) for picking up
10 transmission images of the connected part generated from
the scintillator for a plurality of number of times with
changing a storage time;

a sub thickness image forming device (121) for
forming sub thickness images corresponding to the
15 respective plurality of the transmission images of
different storage times supplied from the imaging device on
the basis of a relationship between a brightness density of
the transmission image and a thickness of the connected
part; and

20 a superimposed image forming device (121) for
forming a thickness superimposed image of the connected
part by adding the plurality of the sub thickness images to
each other.

2. The connection inspecting apparatus according to
25 claim 1, wherein the superimposed image forming device

and collects only valid parts of the plurality of thickness images respectively so as to form a superimposed image.

The connection inspecting apparatus according to the invention herein the image forming device forms first thickness images corresponding to the respective thickness images at the storage times when one of the parts is present along an application direction and also forms second sub thickness images corresponding to each of the transmission images at the storage times in a state with the connected parts when a plurality of the connected parts are overlapping in the application direction.

While the superimposed image forming device forms the thickness superimposed image by adding a plurality of first sub thickness images to each other and forms the second thickness superimposed image by adding a plurality of the second sub thickness images to each other, the device extracts the first thickness superimposed image and the second thickness superimposed image so as to form a superimposed image.

The connection inspecting apparatus according to the invention herein when the connected parts are present on the other face opposite to each other of the parts, the image forming device forms first thickness images corresponding to the respective thickness images at the storage times when one of the parts is present along an application direction and also forms second sub thickness images corresponding to each of the transmission images at the storage times in a state with the connected parts when a plurality of the connected parts are overlapping in the application direction.

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shaped member, the first thickness superimposed image formed by the image forming device corresponds to the connected part at the one face, and the second thickness superimposed image corresponds to the connected parts at both the one and the other face, so that the superimposed image forming device obtains the thickness superimposed image of the connected part at the other face by subtracting the first thickness superimposed image from the second thickness superimposed image.

5. The connection inspecting apparatus according to claim 3, wherein the superimposed image forming device extracts and collects only valid parts from the plurality of the first sub thickness images respectively so as to form the first thickness superimposed image, and moreover extracts and collects only valid parts from the plurality of the second sub thickness images so as to form the second thickness superimposed image.

6. The connection inspecting apparatus according to claim 1, further comprising a teaching jig of a known thickness which is a member for obtaining the relationship between the brightness density of the transmission image and the thickness of the connected part and is formed of a material with a radiation transmittance equal to that of the connected part.

7. A connection inspecting method for inspecting a

connected part, which comprises:

applying a radiation to the connected part of members with an application condition kept invariant, and then converting a radiation passed through the connected part to a visible light;

picking up transmission images of the connected part expressed by the visible light for a plurality of number of times with changing a storage time;

forming sub thickness images corresponding to the respective plurality of the transmission images of different storage times on the basis of a relationship between a brightness density of the transmission image and a thickness of the connected part; and

forming a thickness superimposed image by adding the plurality of sub thickness images to each other so as to inspect the connected part.

8. The connection inspecting method according to claim 7, wherein only valid parts are extracted and collected from the plurality of the sub thickness images respectively so as to form the thickness superimposed image.

9. The connection inspecting method according to claim 7, wherein, when a plurality of connected parts are present overlapping in an application direction of the radiation, the operation of forming the sub thickness images comprises:

first, forming a plurality of first sub thickness images in a state where the one connected part is present along the application direction of the radiation; and

5 next, forming a plurality of second sub thickness images of the different storage times in a state where the plurality of the connected parts are present overlapping in the application direction of the radiation; and

the operation of forming the thickness superimposed image comprises:

10 first, forming a first thickness superimposed image by adding the plurality of the first sub thickness images to each other, and also forming a second thickness superimposed image by adding the plurality of the second sub thickness images to each other; and

15 next, subtracting the first thickness superimposed image from the second thickness superimposed image.

10. The connection inspecting method according to claim 9, wherein the first thickness superimposed image is formed by extracting and collecting only valid parts from the plurality of the first sub thickness images respectively, and the second thickness superimposed image is formed by extracting and collecting only valid parts from the plurality of the second sub thickness images.

25 11. A computer readable recording medium for

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recording programs to make a computer execute:

a process of applying a radiation to a connected part of members with an application condition kept invariant, and converting a radiation passed through the connected part to a visible light;

a process of picking up transmission images of the connected part expressed by the visible light for a plurality of the number of times with changing a storage time;

a process of forming sub thickness images corresponding to the respective transmission images of the different storage times on the basis of a relationship between a brightness density of the transmission image and a thickness of the connected part; and

a process of adding the plurality of sub thickness images to each other so as to form a thickness superimposed image.

12. The recording medium according to claim 11, wherein a program is further recorded for making the computer execute a process of extracting and collecting only valid parts from the plurality of the sub thickness images respectively to form the thickness superimposed image.

13. The recording medium according to claim 11, wherein a program is further recorded for making the

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computer execute, when the connected parts are present at one and the other face opposite to each other of a plate-shaped member, the process of forming the sub thickness image comprising:

5 a process of forming first sub thickness images corresponding to the transmission images at the storage times for the connected part present at the one face; and

10 a process of forming second sub thickness images corresponding to the transmission images of the different storage times in a state where the connected parts are present overlapping at the one and the other face in the application direction of the radiation,

the process of forming the thickness superimposed image comprising:

15 a process of forming a first thickness superimposed image by adding the plurality of first sub thickness images to each other;

20 a process of forming a second thickness superimposed image by adding the plurality of second sub thickness images to each other; and

a process of subtracting the first thickness superimposed image from the second thickness superimposed image so as to form the thickness superimposed image of the connected part present at the other face.

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comprises:

an irradiation device (411) for applying a radiation to a connected part;

5 a scintillator (412) for converting a radiation passed through the connected part to a visible light;

an imaging device (413) for picking up a transmission image of the connected part generated from the scintillator; and

10 an image forming device (451) for forming brightness information on the basis of the transmission image supplied from the imaging device of a first connected part (5011) and a second connected part (5012) of an object (421, 422) to be inspected which overlap at a part (5013) in a thicknesswise direction thereof, and for forming an
15 image of only the second connected part on the basis of the brightness information.

15. The connection inspecting apparatus according to claim 14, wherein the image forming device binarizes the brightness information so as to form the image of only the
20 second connected part by a bright side level ($A+\alpha$) brighter than a reference brightness level (A) of the transmission image of the first connected part when the object has only the first connected part and by a dark side level ($A-\beta$) darker than the reference brightness level.

25 16. The connection inspecting apparatus according to

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claim 15, wherein, based on an image of the overlapping first connected part and second connected part obtained by binarizing the brightness information, an image of only the first connected part obtained by the binarization by the bright side level, and an image of the overlapping part obtained by the binarization by the dark side level, the image forming device deletes the image of only the first connected part from the image of the first and second connected parts, and adds the image of the overlapping part to an image after the deletion so as to form the image of only the second connected part.

17. The connection inspecting apparatus according to claim 14, wherein the image forming device obtains outline position information of the first connected part based on the transmission image of the first connected part, and forms the image of only the second connected part on the basis of the brightness information and the outline position information.

18. The connection inspecting apparatus according to claim 17, wherein the image forming device detects a brightness change at an outline position indicated by the outline position information with the use of the brightness information, obtains each position information of one position (516) and the other position (517) in an outline segment of the overlapping part showing a different

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5 brightness change from other positions, obtains information on a divide line (518) passing the one position and the other position from the position information, and forms the image of only the second connected part from the brightness information by changing a binarization level at a first region (519) including the first connected part and a second region (520) including the second connected part which are divided by the divide line.

10 19. The connection inspecting apparatus according to claim 18, wherein the binarization level formed by the image forming device at the divided first region including the first connected part is a level for extracting only the overlapping part, while the binarization level at the second region including the second connected part is a
15 brightness level of the second connected part obtained when each position information of the one position and the other position is obtained.

20 20. The connection inspecting apparatus according to claim 18, wherein the image forming device obtains each position information of the one position and the other position on the basis of a peak value of the brightness.

25 21. The connection inspecting apparatus according to claim 14, wherein the imaging device picks up the image of the first connected part and the second connected part in the overlap state with changing an image storage time.

22. The connection inspecting apparatus according to claim 18, wherein the imaging device picks up the image of the first connected part and the second connected part in the overlap state with changing an image storage time, and the image forming device obtains the one position and the other position in the outline segment of the overlapping part with the use of the brightness information of a largest brightness change among the brightness information of transmission images for every one of different storage times.

23. The connection inspecting apparatus according to claim 22, wherein the image forming device obtains each position information of the one position and the other position on the basis of the brightness information of a largest peak value of the brightness.

24. A connection inspecting method, which comprises:
applying a radiation to an object (421, 422) to be inspected which has a first connected part (5011) overlapping with a second connected part (5012) at a part (5013) in a thicknesswise direction of the object, and converting a radiation passed through the object to a visible light;

forming brightness information on the basis of a transmission image of the first connected part and the second connected part in the overlap state which is

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deleting the image of only the first connected part from the image of the first connected part and the second connected part, and adding the image of the overlapping part to an image after the deletion, whereby the image of the only the second connected part is formed.

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obtaining outline position information of the first connected part on the basis of a transmission image of the first connected part with the use of the brightness information;

5 detecting a brightness change at an outline position indicated by the outline position information;

obtaining each position information of one position (516) and the other position (517) in an outline segment of the overlapping part showing a different brightness change from other positions;

10 obtaining information on a divide line (518) passing the one position and the other position from the position information; and

binarizing for a first region (519) including the first connected part divided by the divide line by a level in which only the overlapping part is extracted, and binarizing for a second region (520) including the second connected part by a brightness level of the second connected part obtained when each position information of the one position and the other position is obtained, so that the image of only the second connected part is formed from the brightness information.

27. The connection inspecting method according to claim 26, wherein each position information of the one position and the other position is obtained on the basis of

a peak value of the brightness.

28. The connection inspecting method according to claim 24, wherein the first connected part and the second connected part in the overlap state is picked up by changing an image storage time.

29. A computer readable recording medium for recording programs to make a computer execute:

a process of applying a radiation to an object (421, 422) to be inspected which has a first connected part (501) overlapping with a second connected part (5012) at a part (5013) in a thickness direction of the object;

a process of forming brightness information based on a transmission image of the first connected part and the second connected part in the overlap state which is obtained by converting a radiation passed through the object to a visible light; and

a process of forming an image of only the second connected part on the basis of the brightness information.

30. The computer readable recording medium according to claim 29, wherein a program is further recorded for making the computer execute the process of forming the image of only the second connected part which comprises:

a process of binarizing the brightness information so as to obtain an image of the first connected part and the second connected part in the overlap state;

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information;

5 a process of obtaining each position information of one position (516) and the other position (517) in an outline segment of the overlapping part showing a different brightness change from other positions;

a process of obtaining information on a divide line (518) passing the one position and the other position from the position information;

10 a process of binarizing for a first region (519) including the first connected part divided by the divide line by a level in which only the overlapping part is extracted, and binarizing for a second region (520) including the second connected part by a brightness level of the second connected part obtained when each position
15 information of the one position and the other position is obtained, so that the image of only the second connected part is formed from the brightness information.

32. The computer readable recording medium according to claim 29, wherein a program is further recorded for
20 making the computer execute the process of forming the image of only the second connected part which comprises:

a process of obtaining outline position information of the first connected part on the basis of a transmission image of the first connected part with the use
25 of the brightness information;

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a process of detecting a brightness peak value in an outline position indicated by the outline position information;

5 a process of obtaining each position information of one position (516) and the other position (517) of an outline segment of the overlapping part with setting the detected peaks as the one position and the other position;

10 a process of obtaining information on a divide line (518) passing the one position and the other position from the position information;

15 a process of binarizing for a first region (519) including the first connected part divided by the divide line by a level in which only the overlapping part is extracted, and binarizing for a second region (520) including the second connected part by a brightness level of the second connected part obtained when each position information of the one position and the other position is obtained, so that the image of only the second connected part is formed from the brightness information.

20 33. The computer readable recording medium according to claim 29, wherein a program is further recorded for making the computer execute the process of forming brightness information based on the transmission image of the first connected part and the second connected part in
25 the overlap state by picking up the image of the first

connected part and second connected part with changing an
image storage time.

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